# 57

## ECMF02-4CMX8

## Common mode filter with ESD protection for USB 2.0 Interface

Datasheet - production data

#### **Features**

- Integrated common mode filter
- Differential pair ESD protection
- 16 V V<sub>BUS</sub> ESD and EOS protection
- ID pin ESD protection
- Low profile µQFN-8L package
- High bandwidth: >6 GHz
- Optimized for high speed USB 2.0
- High common mode attenuation at 900 MHz and 1.8 GHz
- Support of audio over USB 2.0 thanks to bidirectional ESD protection
- Ultra compact, low board space
- Low height: < 0.55 mm

#### Complies with the following standards:

- IEC 61000-4-2 level 4:
  - ±15 kV (air discharge)
  - ±8 kV (contact discharge)
- RoHS2 compliant

#### **Applications**

Where transient over-voltage protection in ESD sensitive equipment is required, such as:

- Computers
- Printers
- Communication systems
- Cellular phone handsets and accessories
- Video equipment

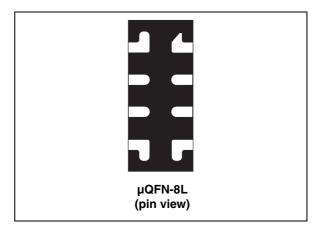
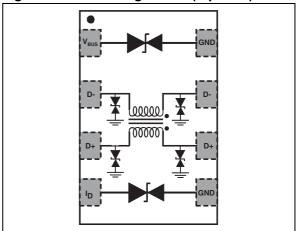


Figure 1. Pin configuration (top view)



#### **Description**

ECMF02-4CMX8 affords key component integration such as common mode filter D+ and D- lines and ESD protection on all lines. This device offers an optimized flow-through footprint for USB 2.0 applications.

## 1 Characteristics

Table 1. Absolute maximum ratings  $(T_{amb} = 25 \, ^{\circ}C)$ 

Symbol		Value	Unit	
V <sub>PP</sub>	Peak pulse voltage <sup>(1)</sup>	ESD discharge IEC 61000-4-2, level 4 Contact discharge on D+/D- pins Contact discharge on V <sub>BUS</sub> and I <sub>D</sub> pins Air discharge on all pins	10 20 30	kV
P <sub>PP</sub>	Peak pulse power (8/20μs) on V <sub>BUS</sub>		150	W
I <sub>PP</sub>	Peak pulse current (8/20µs) on V <sub>BUS</sub>		4.8	Α
T <sub>op</sub>	Operating temperature		-30 to +85	°C
Tj	Maximum junction temperature		125	°C
T <sub>stg</sub>	Storage temperature range		- 55 to +150	°C

<sup>1.</sup> Measurements done on IEC 61000-4-2 test bench. For further details see Application note AN3353.

Figure 2. Electrical characteristics - definitions

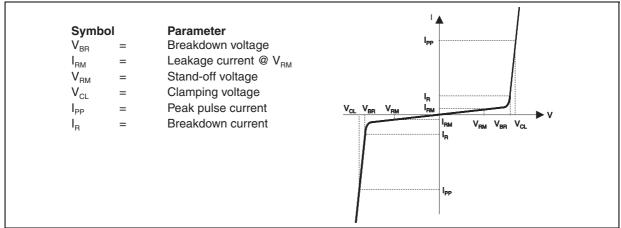


Table 2. Electrical characteristics (values,  $T_{amb} = 25$  °C)

Symbol	Test conditions	Min.	Тур.	Max.	Unit		
	Data Lines						
V <sub>BR</sub>	I <sub>R</sub> = 1 mA 6				V		
I <sub>RM</sub>	V <sub>RM</sub> = 5.5 V per line			100	nA		
R <sub>DC</sub>	DC serial resistance on data line		3	4	Ω		
V <sub>BUS</sub>							
V <sub>BR</sub>	I <sub>R</sub> = 1 mA 15 16.5 18		V				
I <sub>RM</sub>	V <sub>RM</sub> = 12 V			50	nA		
V <sub>CL</sub>	Clamping voltage. $I_{PP} = 1 \text{ A}, t_p = 8/20 \mu \text{s}$			20	V		
V <sub>CL</sub>	Clamping voltage. $I_{PP} = 2.5 \text{ A}, t_p = 8/20 \mu\text{s}$			24	V		
I <sub>D</sub>							
V <sub>BR</sub>	I <sub>R</sub> = 1 mA 6		V				
I <sub>RM</sub>	V <sub>RM</sub> = 1.5 V per line			100	nA		

Figure 3. SDD21 differential attenuation measurement (Z $_{0 \text{ diff}}$  = 90  $\Omega$ ) for data lines D+ and D-

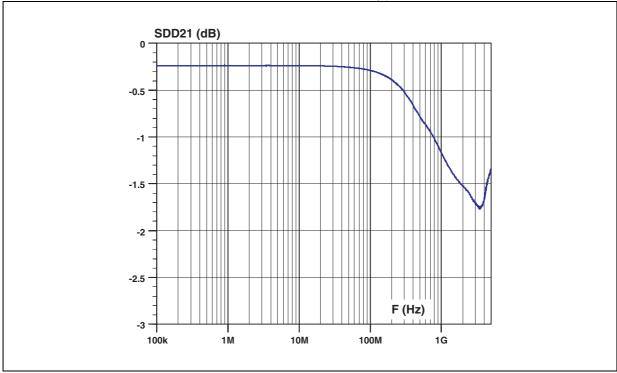


Figure 4. SCC21 common mode attenuation measurement ( $Z_{0 \text{ com}} = 45 \Omega$ )

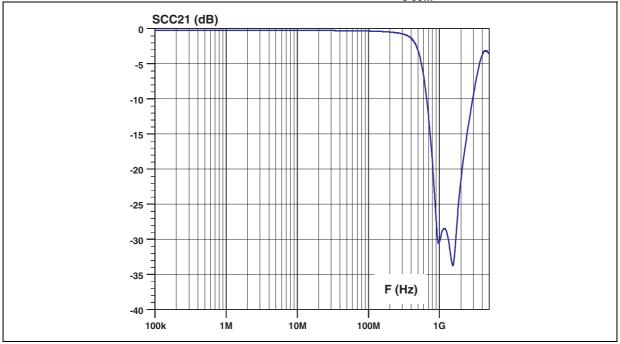


Figure 5. ID frequency response measurement ( $Z_0 = 75 \Omega$ )

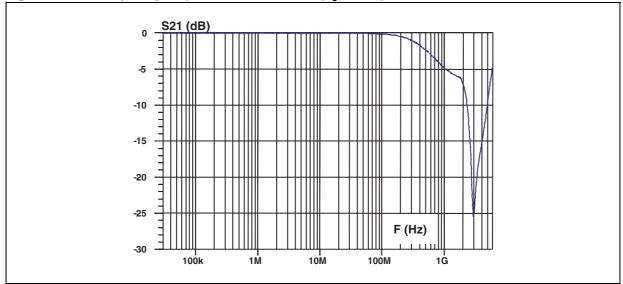


Figure 6. ESD test conditions

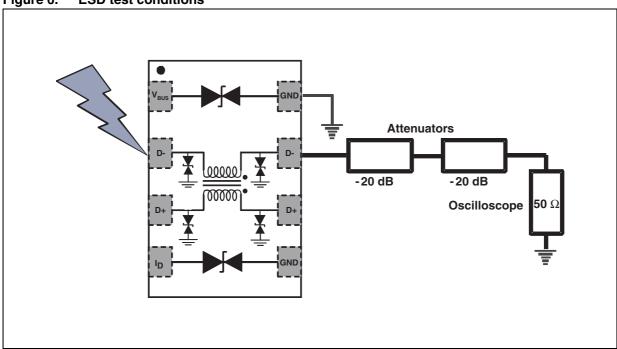
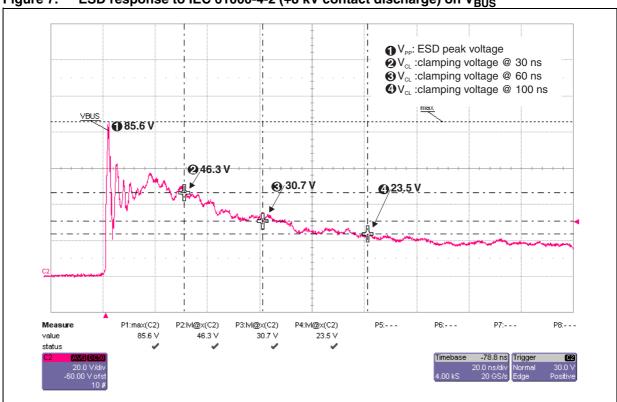
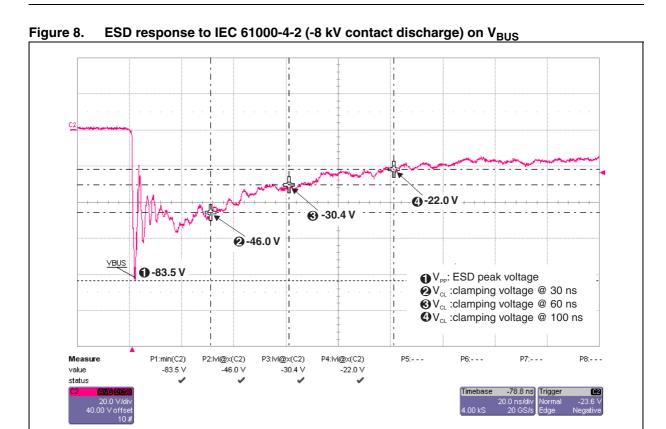
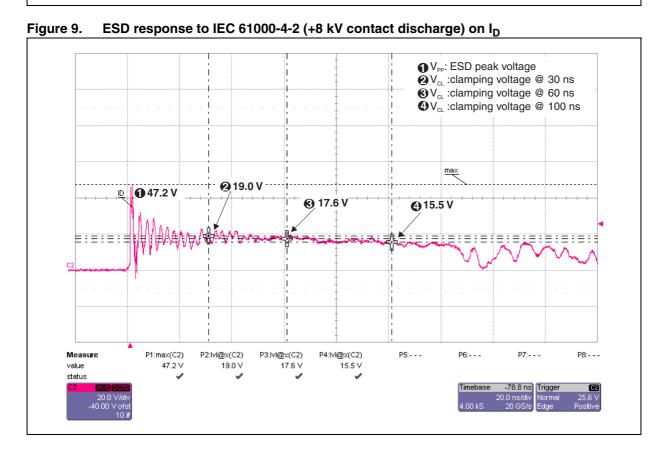


Figure 7. ESD response to IEC 61000-4-2 (+8 kV contact discharge) on V<sub>BUS</sub>









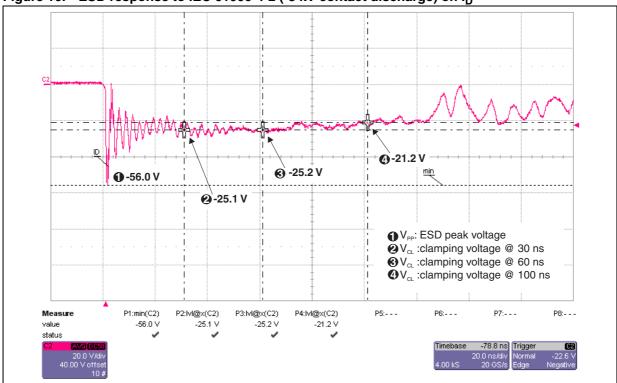
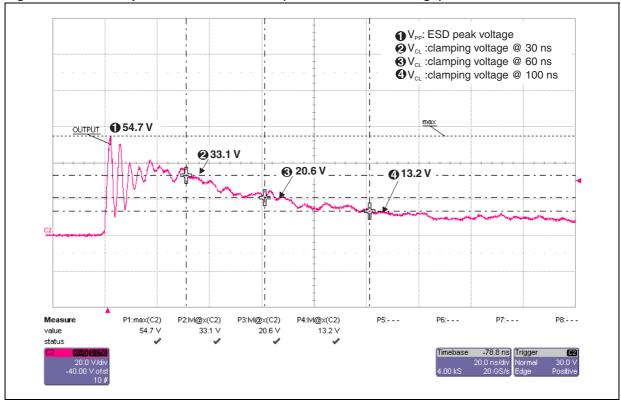


Figure 11. ESD response to IEC 61000-4-2 (+8 kV contact discharge) on differential lane



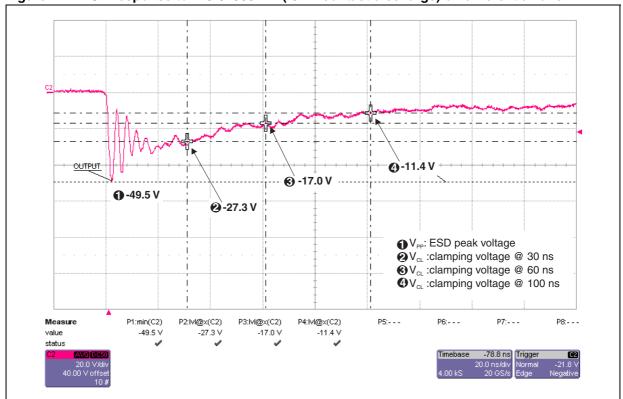
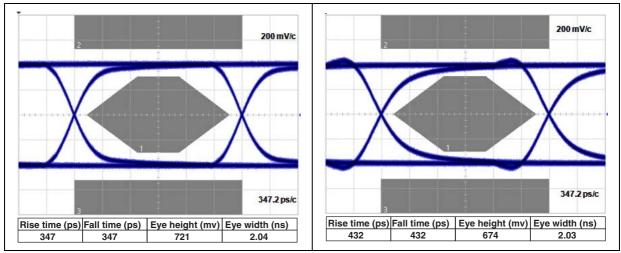


Figure 12. ESD response to IEC 61000-4-2 (-8 kV contact discharge) on differential lane

Figure 13. Eye diagram (loaded by  $Z_{diff}$  = 90  $\Omega$ ) Figure 14. Eye diagram (toaded by  $Z_{diff}$  = 90  $\Omega$ ) Figure 14. Eye diagram with USB2.0 [mask 1] board only







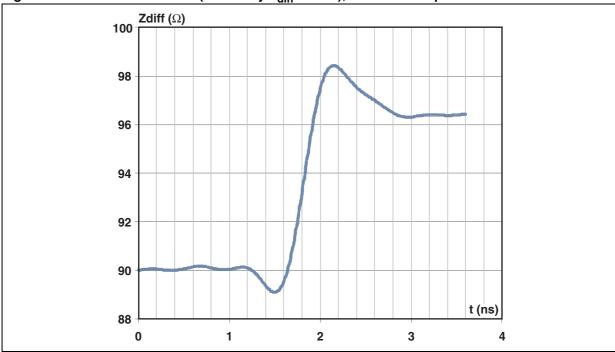


Figure 16. HS sync

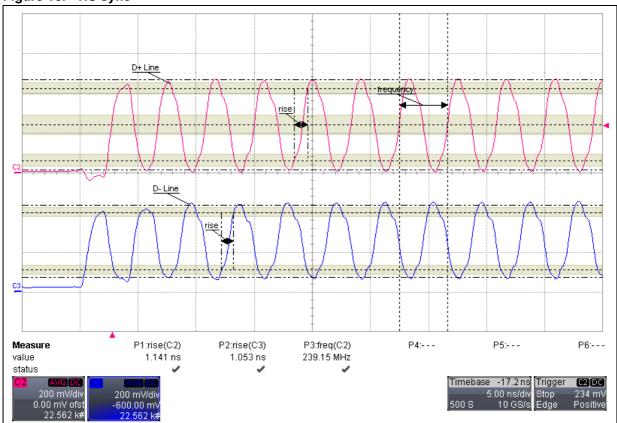


Figure 17. Total harmonic distortion on differential lanes

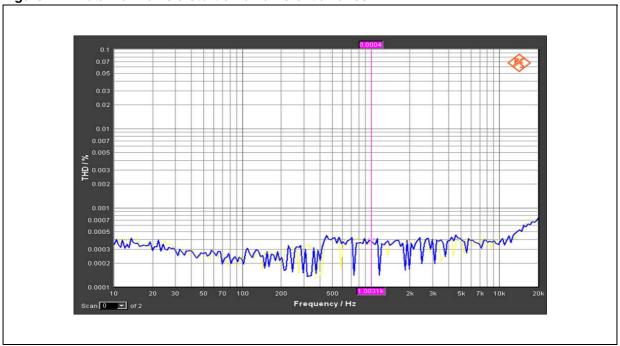
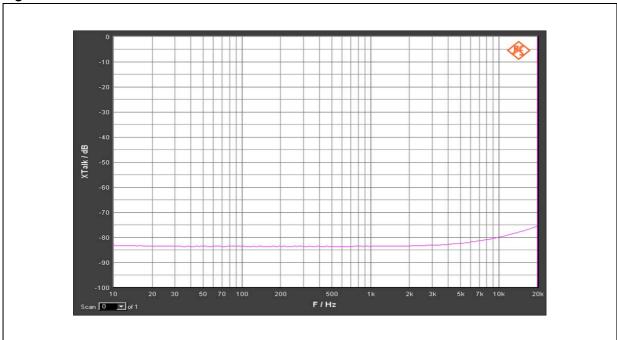


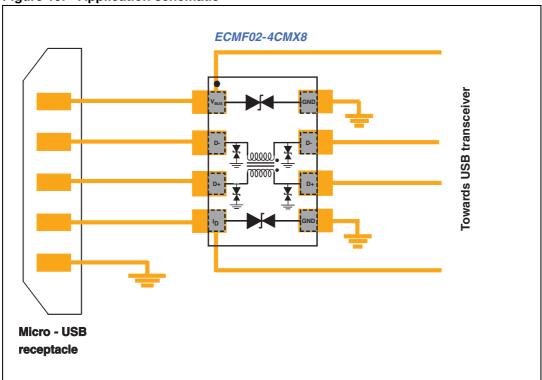
Figure 18. Crosstalk on differential lanes



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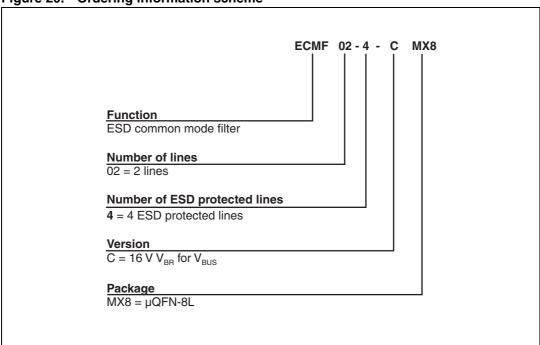
# 2 Application schematic

Figure 19. Application schematic



# 3 Ordering information scheme

Figure 20. Ordering information scheme



## 4 Package information

- Epoxy meets UL94, V0
- Lead-free packages

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK<sup>®</sup> packages, depending on their level of environmental compliance. ECOPACK<sup>®</sup> specifications, grade definitions and product status are available at: www.st.com. ECOPACK<sup>®</sup> is an ST trademark.

Figure 21. µQFN-8L dimension definitions

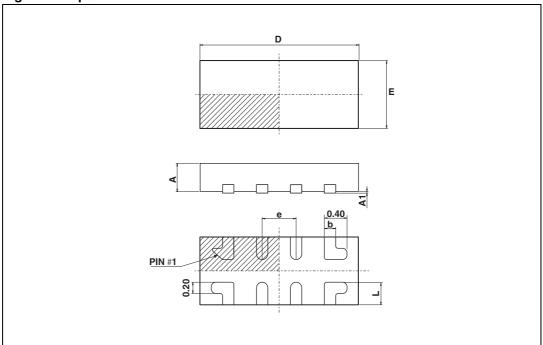


Table 3. µQFN-8L dimension values

	Dimensions						
Ref.	Millimeters			Inches			
	Min.	Тур.	Max.	Min.	Тур.	Max.	
Α	0.45	0.50	0.55	0.018	0.020	0.022	
A1	0.00	0.02	0.05	0.00	0.0008	0.002	
b	0.15	0.20	0.25	0.006	0.008	0.010	
D	2.45	2.50	2.55	0.096	0.098	0.100	
Е	1.15	1.20	1.25	0.045	0.047	0.049	
е	0.45	0.50	0.55	0.018	0.020	0.022	
L	0.30	0.40	0.50	0.012	0.016	0.020	

Package information ECMF02-4CMX8

Figure 22. Footprint

Figure 23. Marking

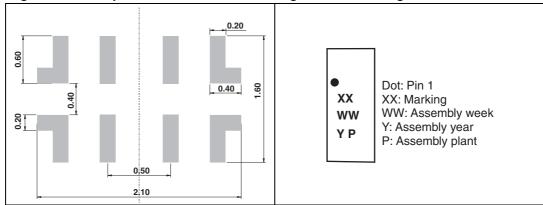
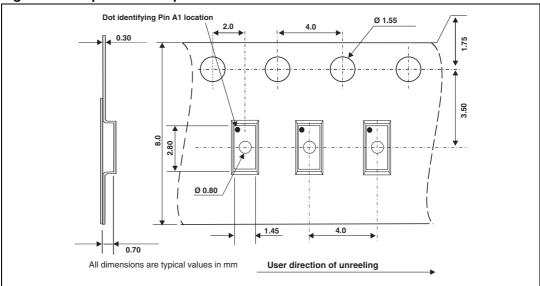


Figure 24. Tape and reel specifications



Note: More packing information is available in the application notes: AN1751: "EMI Filters: Recommendations and measurements"

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# 5 Ordering information

Table 4. Ordering information

Order code	Marking	Package	Weight	Base qty	Delivery mode
ECMF02-4CMX8	KG	μQFN-8L	3,7 mg	3000	Tape and reel

For the latest information on available order codes see the product pages on: www.st.com.

## 6 Revision history

Table 5. Document revision history

Date	Revision	Changes
19-Sep-2012	1	Initial release.

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